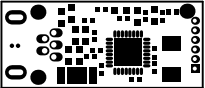


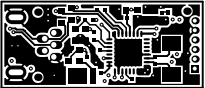
Z22  
Z23  
Z24



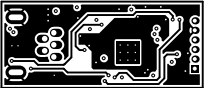
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	SAT0045	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME = Top Overlay						
PLOT NAME = Top Overlay	GENERATED	: 6/13/2013	4:47:58 PM	TEXAS INSTRUMENTS		



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 6/13/2013 4:47:59 PM	TEXAS INSTRUMENTS	



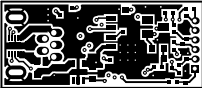
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 6/13/2013 4:47:59 PM		TEXAS INSTRUMENTS



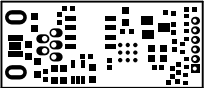
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Mid Layer1			
PLOT NAME = Inner Layer 1	GENERATED : 6/13/2013 4:48:00 PM	TEXAS INSTRUMENTS	



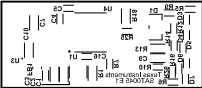
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Mid Layer2			
PLOT NAME = Inner Layer 2	GENERATED : 6/13/2013 4:48:00 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 6/13/2013 4:48:01 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 6/13/2013 4:48:02 PM		TEXAS INSTRUMENTS

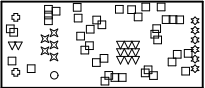


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 6/13/2013 4:48:02 PM	TEXAS INSTRUMENTS	

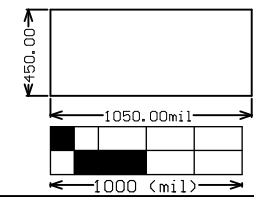
Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	Hole Type
▽	11	7.874mil (0.2mm)			PTH	Round
○	1	8mil (0.203mm)			PTH	Round
□	40	10mil (0.254mm)			PTH	Round
✱	6	22mil (0.559mm)			PTH	Round
⌘	5	29.528mil (0.75mm)			PTH	Round
⊙	2	29.528mil (0.75mm)	76.772mil (1.95mm)	47.244mil (1.2mm)	PTH	Slot
	65 Total					

Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end centre position.  
Physical Length = Rout Path Length + Tool Size = Slot length as defined in the PCB layout

Drill Table



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 6/13/2013 4:48:03 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0045	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 6/13/2013 4:48:03 PM	TEXAS INSTRUMENTS	

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